

# SGM4073 Configurable Reset Timer with Integrated Load Switch

#### GENERAL DESCRIPTION

The SGM4073 is both a timer for resetting a mobile device and an advanced load management switch for applications requiring a highly integrated solution.

If the mobile device is off, holding nSR0 low (by pressing power-on key) for 1.9s turns on the PMIC.

As a reset timer, it has one input and one fixed delay output. It generates a fixed delay of 7.7s by disconnecting the PMIC from the battery power supply for 468ms. Then the load switch is turned on again to reconnect the battery to the PMIC such that PMIC goes into power-on sequence. The reset delay can be customized by connecting an external resistor to the DELAY\_ADJ pin. Refer to Table 4.

As an advanced load management switch, the SGM4073 disconnects loads powered from the DC power rail (< 6V) with stringent off-state current targets and high load capacitances (up to  $200\mu F$ ). The SGM4073 consists of a slew rate controlled low-impedance MOSFET switch ( $20m\Omega$  typical at 3.6V) that has exceptionally low off-state current drain to facilitate compliance with standby power requirements. The slew rate controlled turn-on characteristic prevents inrush current and the resulting excessive voltage drop on power rails.

The low  $I_{\rm Q}$  enables direct interface to lower-voltage chipsets without external translation, while maintaining low power consumption.

The SGM4073 operates over an ambient temperature range of -40  $^{\circ}$ C to +85  $^{\circ}$ C. It is available in Green WLCSP-1.31×1.62-12B package.

#### **FEATURES**

- Input Voltage Operating Range: 1.5V to 5.5V
- Factory Programmed Reset Delay: 7.7s
- Factory Programmed Reset Pulse: 468ms
- Factory Customized Turn-On Time: 1.9s
- Factory Customized Turn-Off Delay: 7.7s
- Adjustable Reset Delay Option with External Resistor
- Low I<sub>Q</sub> Saves Power Interfacing to Low-Voltage Chips
- OFF Pin Turns Off Load Switch to Maintain Battery Charge during Shipment and Inventory. Ready to Use Right Out of the Box
- Typical R<sub>ON</sub>:  $20m\Omega$  (TYP) at V<sub>BAT</sub> = 3.6V
- Slew Rate/Inrush Control with t<sub>R</sub>: 3ms (TYP)
- 6A Maximum Continuous Current
- Output Capacitor Discharge Function during Reset Period
- Zero-Second Test-Mode Enable
- Available in Green WLCSP-1.31×1.62-12B Package

#### **APPLICATIONS**

Smart Phones, Tablet PCs
Storage, DSLR and Portable Devices



#### PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION	
SGM4073	WLCSP-1.31×1.62-12B	-40°C to +85°C	SGM4073YG/TR	XXXX 4073	Tape and Reel, 3000	

#### MARKING INFORMATION

NOTE: XXXX = Date Code.



Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

#### **ABSOLUTE MAXIMUM RATINGS**

$V_{\text{BAT}}$ to GND0.3V to 6.5V $V_{\text{OUT}}$ to GND0.3V to 6.5V Maximum Continuous Switch Current6A
Power Dissipation, $P_D$ @ $T_A$ = 25°C, $I_{OUT}$ = 6A, $R_{ON}$ = 20m $\Omega$
0.72W
Package Thermal Resistance
WLCSP-1.31×1.62-12B, θ <sub>JA</sub> 86°C/W
DC Input Voltage
nSR0, DSR, OFF, DELAY_ADJ, SYS_WAKE0.5V to 6.5V
DC Input Diode Current, V <sub>BAT</sub> < 0V50mA
Junction Temperature+150°C
Storage Temperature Range65°C to +150°C
Lead Temperature (Soldering, 10s)+260°C
ESD
HBM8000V
MM400V
CDM1000V

#### RECOMMENDED OPERATING CONDITIONS

Input Voltage Range	
V <sub>BAT</sub>	1.5V to 5.5V
nSR0, DSR, OFF, SYS_WAKE	0V to 5.5V
Output Voltage Range	0V to V <sub>BAT</sub>
Operating Temperature Range	40°C to +85°C

#### **OVERSTRESS CAUTION**

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

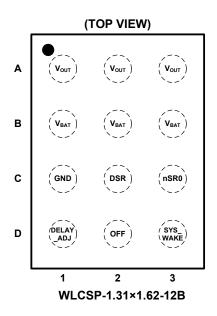
#### **ESD SENSITIVITY CAUTION**

This integrated circuit can be damaged by ESD if you don't pay attention to ESD protection. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

#### **DISCLAIMER**

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

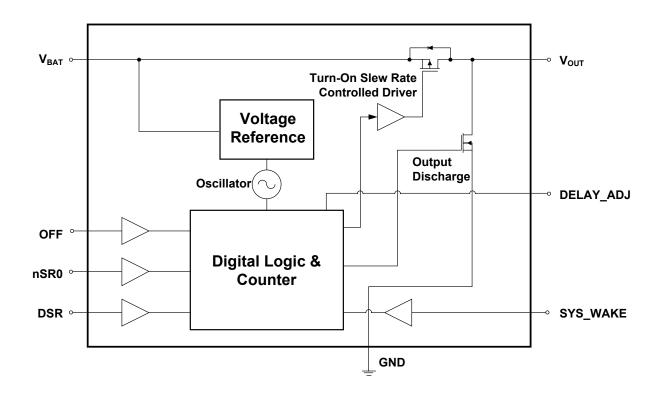
# **PIN CONFIGURATION**



# **PIN DESCRIPTION**

		FUNCTION					
PIN	NAME	Normal Operation	Zero-Second Factory-Test Mode (Only for t <sub>VON</sub> and t <sub>PHL</sub> )				
A1, A2, A3	V <sub>OUT</sub>	Switch Output.	Switch Output.				
B1, B2, B3	$V_{BAT}$	Supply Input.	Supply Input.				
C1	C1 GND Ground.		Ground.				
C2	DSR	Delay Selection Input. It's connected to GPIO with $100k\Omega$ pull-up or to $V_{BAT}$ directly without pull-up resistor.	Logic LOW.				
C3	nSR0	Power-On or Reset Input. Active LOW. Dampproof and anti-creeping input.	Logic LOW.				
D1	DELAY_ADJ	Reset Delay Adjustment. Must tie to $V_{BAT}$ directly if not used. To adjust the reset delay, a resistor ( $R_{ADJ}$ ) is connected between this pin and ground.	Connected to V <sub>BAT</sub> or GND.				
D2 OFF I		Load Switch Disable. Rising edge triggered, changes load switch from ON state to OFF state. The OFF pin cannot be left floating.	High or Low.				
D3	SYS_WAKE	System Wake-Up Input. Changes load switch from OFF state to ON state. Dampproof and anti-creeping input.	High or Low.				

# **FUNCTIONAL BLOCK DIAGRAM**



# **ELECTRICAL CHARACTERISTICS**

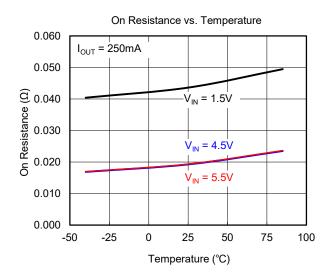
 $(V_{BAT} = 3.6V \text{ and } T_A = +25^{\circ}C, \text{ unless otherwise noted.})$ 

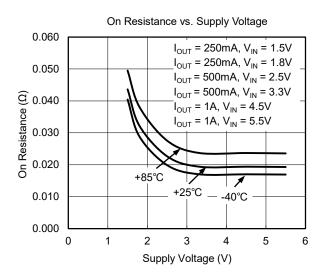
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
BASIC OPERATION						
Shutdown Current	I <sub>SD</sub>	VOUT Floating, Load Switch = OFF		0.7	1.5	μA
		V <sub>BAT</sub> = 5.5V, I <sub>OUT</sub> = 500mA		18	36	
On Resistance	R <sub>on</sub>	V <sub>BAT</sub> = 3.6V, I <sub>OUT</sub> = 500mA		20	37	mΩ
		V <sub>BAT</sub> = 1.5V, I <sub>OUT</sub> = 500mA		42	87	1
Output Discharge R <sub>PULL-DOWN</sub>	R <sub>PD</sub>	Reset Period, I <sub>FORCE</sub> = 10mA		65	90	Ω
Input High Voltage	V <sub>IH</sub>		1.2			V
Input Low Voltage	V <sub>IL</sub>				0.4	V
Input Leakage Current (1)	I <sub>IN</sub>	0V ≤ V <sub>BAT</sub> ≤ 5.5V			1.5	μA
Decree On Decret Three-body	V <sub>POR</sub>			1.38	1.5	.,
Power-On Reset Threshold	V <sub>HYS</sub>			0.1		V
Quiescent Current	IQ	nSR0 = 3.6V, DSR = 3.6V, SYS_WAKE = GND, OFF = GND, I <sub>OUT</sub> = 0mA, Load Switch = ON		1	2	μA
Force Voltage Threshold	V <sub>COERU</sub>	SYS_WAKE up going	0.7			V
Force Voltage Threshold	V <sub>COERD</sub>	nSR0 down going	SR0 down going 0.6			
Force Current Threshold	I <sub>COERSNK</sub>	SYS_WAKE up going -5		-50		μΑ
Torce Current Tilleshold	I <sub>COERSRC</sub>	nSR0 down going		45		μΑ
Discharging Residual Voltage	V <sub>DIS</sub>			0.4		V
POWER-ON AND RESET TIMING						
Turn-On Time for V <sub>OUT</sub>	t <sub>von</sub>	$R_L$ = 5kΩ, DSR = HIGH, Figure 1	1.4	1.9	2.4	s
Timer Delay before Reset	t <sub>PHL</sub>	$R_L$ = 5k $\Omega$ , DSR = HIGH, Figure 2	6.2	7.7	9.2	s
Reset Timeout Delay of V <sub>OUT</sub>	t <sub>REC</sub>	$R_L$ = 5kΩ, Figure 2	376	468	541	ms
LOAD SWITCH TURN-ON TIMING						
Turn-On Delay Time	t <sub>DON</sub>			4		ms
V <sub>OUT</sub> Rise Time	t <sub>R</sub>	$R_L = 5\Omega$ , $C_L = 100\mu F$ , Figure 3		3		ms
Turn-On Time, SYS_WAKE to $V_{\text{OUT}}$	t <sub>ON</sub>			7		ms
LOAD SWITCH TURN-OFF WITH DELA	·Υ					
Delay to Turn Off Load Switch	t <sub>SD</sub>		6.2	7.7	9.2	s
V <sub>OUT</sub> Fall Time	t <sub>F</sub>	$R_L$ = 150Ω, $C_L$ = 100μF, DSR = HIGH, Figure 4		10		ms
Turn-Off Time	t <sub>OFF</sub>			7.7		s
LOAD SWITCH ZERO-SECOND TURN-	OFF					
Delay to Turn Off Load Switch	t <sub>SD</sub>			2		ms
V <sub>OUT</sub> Fall Time	t <sub>F</sub>	$R_L = 150\Omega$ , $C_L = 100\mu$ F, DSR = LOW, Figure 4		10		ms
Turn-Off Time	t <sub>OFF</sub>			12		ms
ZERO-SECOND FACTORY-TEST MOD	<b>=</b>					
Turn-On Time for V <sub>OUT</sub>	t <sub>VON</sub>	$C_L$ = 5pF, $R_L$ = 5k $\Omega$ , Load Switch = OFF, DSR = LOW, Figure 1		6.3		ms
Timer Delay before Reset	t <sub>PHL</sub>	$C_L$ = 5pF, $R_L$ = 5k $\Omega$ , Load Switch = ON, DSR = LOW, Figure 2		1.4		ms

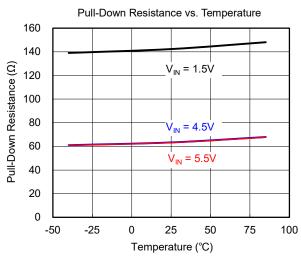
NOTE 1: Input pins are nSR0, OFF, DSR, and SYS\_WAKE.

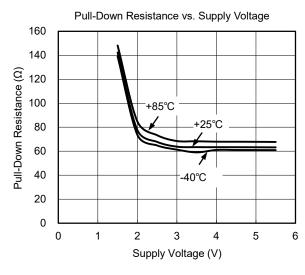


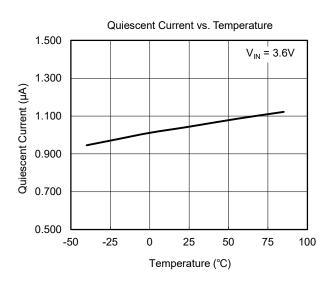
# TYPICAL PERFORMANCE CHARACTERISTICS

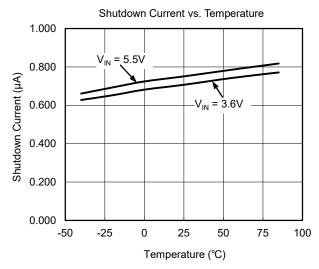




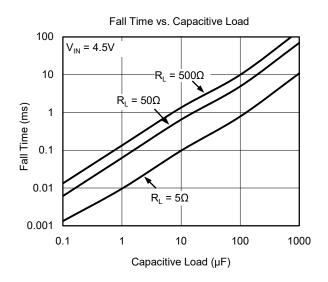


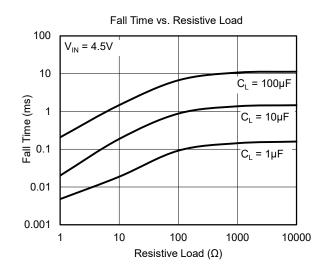


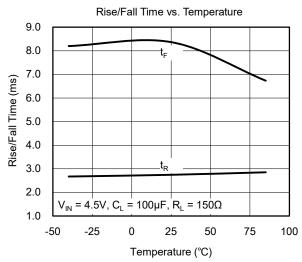


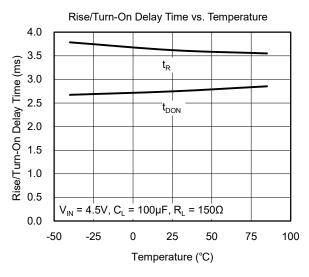


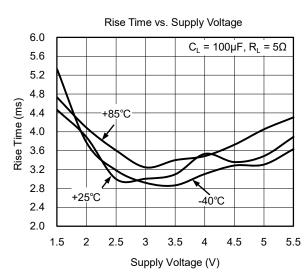
# **TYPICAL PERFORMANCE CHARACTERISTICS (continued)**

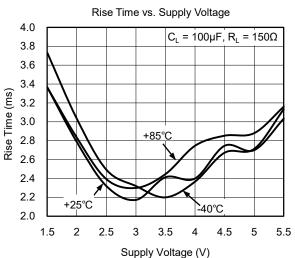




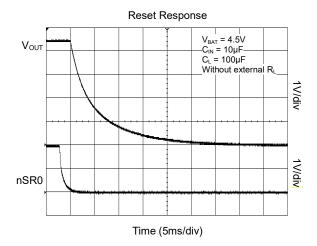








# **TYPICAL PERFORMANCE CHARACTERISTICS (continued)**



#### **TIMING DIAGRAMS**

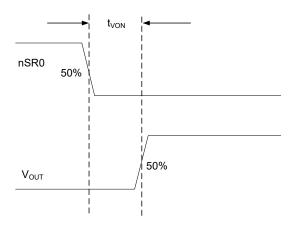


Figure 1. Power-On with nSR0

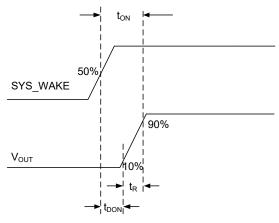


Figure 3. Timing Diagram (SYS\_WAKE vs. VOUT)

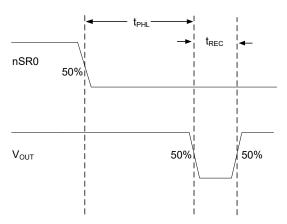


Figure 2. RESET Timing

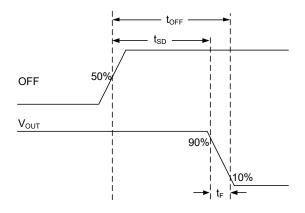


Figure 4. Timing Diagram (OFF vs. VOUT)

# TYPICAL APPLICATION CIRCUITS

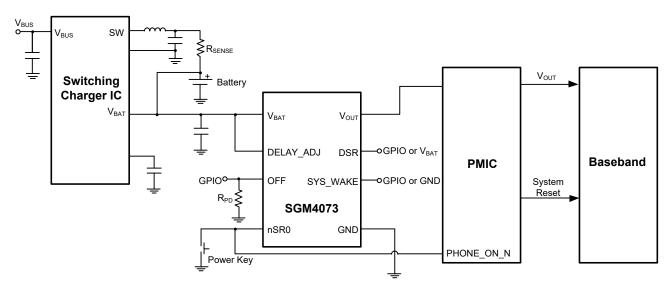


Figure 5. Typical Application with a Stand Alone Switching Charger IC

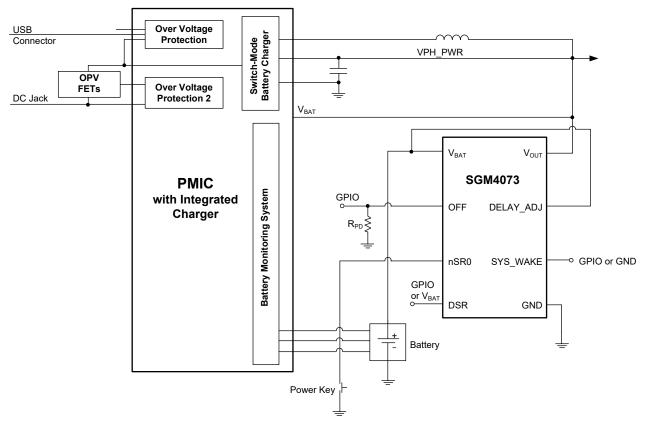


Figure 6. Typical Application PMIC with a Integrated Charger

### **APPLICATION INFORMATION**

# Reset Timer and Advanced Load Management

The SGM4073 is both a reset IC and an advanced load management device. Typical applications are shown in Figure 5 and Figure 6. SGM4073 does not need pull-up circuit like \*75939 for nSR0 pin's anti-creeping. Dampproof makes it more robust, and SGM4073 can also replace \*75939 in circuit directly.

#### Power-On

There are two methods to turn on the load switch to wake up the PMIC. When a HIGH is applied to the SYS\_WAKE pin or when nSR0 is held LOW for > 1.9s (see Figure 1), the SGM4073 turns on its load switch to allow PMIC to connect to the battery. The reset feature is disabled when  $V_{\text{OUT}}$  is toggled from OFF to ON. Continuously holding nSR0 LOW does not trigger a reset event.

To enable the reset feature, nSR0 must return to HIGH such that SGM4073 resets its internal counter.

#### **Reset Timer**

During normal operation of a mobile device, if a reset operation is needed for mobile equipment, holding the power switch, to which nSR0 is connected and is forced LOW, for at least 7.7s, causes the SGM4073 to cut off the supply power to PMIC for 468ms by turning off the load switch. If after 468ms,  $V_{\text{OUT}}$  is less than  $V_{\text{DIS}}$  (0.4V), the SGM4073 then automatically turns on the load switch to reconnect the PMIC to battery. If after 468ms,  $V_{\text{OUT}}$  is larger than  $V_{\text{DIS}}$  (0.4V), the SGM4073 will not turn on the load switch to reconnect the PMIC to battery until  $V_{\text{OUT}}$  is less than  $V_{\text{DIS}}$ . This forces PMIC to enter a power-on sequence.

If the power switch is released and nSR0 is returned to HIGH within 7.7s, the SGM4073 resets its counter and  $V_{\text{OUT}}$  remains in ON state; there is no change on  $V_{\text{OUT}}$  and a reset does not occur.

#### **Disconnect PMIC from Battery (Turn-Off)**

After holding the DSR pin HIGH, changing the OFF pin from LOW to HIGH (rising edge triggered) and holding it HIGH for at least 2ms, the SGM4073 triggers an internal counter to allow a factory-customized 7.7s delay before turning off internal load switch. The delay is intended to allow the PMIC to complete a power-down sequence before safely disconnected from the power supply. However, the turn-off sequence is terminated if a higher priority input is detected in  $t_{\rm SD}$  period (see Resolving Input Conflicts section).

Alternatively, after holding the DSR pin LOW, changing the OFF pin from LOW to HIGH (rising edge triggered) and holding it HIGH for at least 2ms, the SGM4073 triggers the zero-second turn-off. Delay  $t_{\rm SD}$  is significantly reduced to 2ms to avoid the default delay time to turn off load switch.

With its low shutdown current, the SGM4073 significantly reduces the current drain on a battery when the PMIC is turned off. In other words, it preserves the battery power for a longer period when a mobile device is in shutdown mode.

#### **Power-On Reset**

When SGM4073 is connected to a battery ( $V_{BAT} \ge 1.38V$ ), the part gets into Power-On Reset (POR) Mode. All internal registers are reset and  $V_{OUT}$  is ON at the end of POR sequence (see Table 2).

Table 1. Vout and Input Conditions

FUNCTION		INITIAL CON	NDITIONS (t = 0s	)	ASSOCIATED		V <sub>OUT</sub>
FUNCTION	nSR0	SYS_WAKE	OFF	DSR	DELAY	BEFORE	AFTER
Power-On	LOW	X	X	LOW	t <sub>VON</sub> = 10ms	OFF	ON
Power-On	LOW	Х	Х	HIGH	t <sub>VON</sub> = 1.9s	OFF	ON
	LOW	X	X	LOW	t <sub>PHL</sub> = 2ms	ON	High to Low to High
Reset	LOW	Х	Х	HIGH	$t_{PHL} = 7.7s$ $t_{REC} = 468ms$	ON	High to Low to High
Turn-Off	HIGH	LOW	Rising Edge	LOW	t <sub>SD</sub> = 2ms	ON	OFF
Tulli-Oil	HIGH	LOW	Rising Edge	HIGH	$t_{SD} = 7.7s$	ON	OFF

NOTE: X = HIGH or LOW.

Table 2. Pin Condition after POR

PIN NAME	nSR0	DSR	SYS_WAKE	OFF	V <sub>OUT</sub>
Default State (after POR)	1	1	0	0	ON

NOTE: 1 = Input Logic HIGH, 0 = Input Logic LOW, ON = Load switch is ON state.



## **APPLICATION INFORMATION (continued)**

#### **Zero-Second Factory-Test Mode**

SGM4073 includes a Zero-Second Factory Test Mode to shorten the turn-on time for  $V_{OUT}$  ( $t_{VON}$ ) and timer delay before reset ( $t_{PHL}$ ) for factory testing.

When  $V_{\text{OUT}}$  is OFF, the default turn-on time ( $t_{\text{VON}}$ ) is 1.9s. If the DSR pin is LOW prior to nSR0 going LOW, the SGM4073 bypasses the 1.9s delay and  $V_{\text{OUT}}$  is changed from OFF to ON immediately.

Similarly, default reset delay ( $t_{PHL}$ ) is 7.7s. If  $V_{OUT}$  is ON and the DSR pin is LOW prior to nSR0 going LOW, the SGM4073 enters Zero-Second Factory Test Mode and bypasses the default reset delay of 7.7s;  $V_{OUT}$  is pulled from ON to OFF immediately. The reset pulse ( $t_{REC}$ ) remains at 468ms in Zero-Second Factory Test Mode.

The DSR pin should never be left floating during normal operation.

#### **Resolving Input Conflicts**

The SGM4073 allows multiple simultaneous inputs and can resolve conflicts based on the priority level (see Table 3). When two input pins are triggered at the same time, only the higher priority input is served and the lower priority input is ignored. To have the lower priority signal serviced, it must be repeated.

**Table 3. Input Priority** 

INPUT	PRIORITY (1 = HIGHEST)
nSR0	1
SYS_WAKE	2
OFF	3

#### Special Note on OFF Pin

In the  $t_{\text{SD}}$  period (DSR = HIGH only, see Figure 4), if nSR0 or SYS\_WAKE is triggered when 0 < t <  $t_{\text{SD}}$ , the SGM4073 exits the turn-off sequence and  $V_{\text{OUT}}$  remains in ON state. The higher priority input is served regardless of the condition of the OFF pin.

In order to re-initiate the turn-off sequence, the OFF pin must return to LOW, then toggle from LOW to HIGH again. The same input priority applies (Table 3) if DSR = HIGH.

# Adjustable Reset Delay with an External Resistor and DSR

The reset delay is adjustable by connecting a commonly available, low-power,  $\pm 5\%$ , POHS-compliant resistor between the DELAY\_ADJ pin and the GND pin (Table 4). To disable the adjustable delay feature, DELAY\_ADJ should be tied to  $V_{BAT}$  directly.

The reset delay is factory programmed at 7.7s.

The additional power consumption caused by using an external resistor is negligible. The external resistor is normally disconnected and is connected for milliseconds when nSR0 is pulled LOW.

This external adjustment feature provides a simple alternative method for controlling delay time for engineering and production at customer's location.

We can also factory program a wide range of turn-on times for  $V_{\text{OUT}}$   $(t_{\text{VON}})$ , timer delay before reset  $(t_{\text{PHL}}),$  reset timeout delay for  $V_{\text{OUT}}$   $(t_{\text{REC}}),$  and load switch turn-off time  $(t_{\text{OFF}})$  to match customer applications. In this case, the external resistor  $(R_{\text{ADJ}})$  can be eliminated.

Table 4. Delay Adjustment vs. External Resistor

EXTERNAL RESISTOR $R_{ADJ}$ ( $k\Omega$ )	DELAY MULTIPLIER
Tie to GND (No Resistor)	0.50 × t <sub>PHL</sub>
3.9	0.75 × t <sub>PHL</sub>
10	1.25 × t <sub>PHL</sub>
22	1.50 × t <sub>PHL</sub>
47	1.75 × t <sub>PHL</sub>
120	2.00 × t <sub>PHL</sub>
Tie to V <sub>BAT</sub> (No Resistor)	1.00 × t <sub>PHL</sub>

#### **Input Capacitor**

The switch inside the reset timer doesn't require an input capacitor. To reduce device inrush current, a 0.1µF ceramic capacitor,  $C_{\text{IN}}$ , is recommended close to the  $V_{\text{BAT}}$  pin. A higher value of  $C_{\text{IN}}$  can be used to reduce the voltage drop experienced as the switch is turned on into a large capacitive load.

#### **Output Capacitor**

While the load switch works without an output capacitor, if parasitic board inductance forces  $V_{\text{OUT}}$  below GND when switching off, a  $0.1\mu\text{F}$  capacitor,  $C_{\text{OUT}}$ , should be placed between  $V_{\text{OUT}}$  and GND.

#### **Fall Time**

Device output fall time can be calculated based on the RC constant of the external components, as follows:

$$t_{F} = R_{L} \times C_{L} \times 2.2 \tag{1}$$

where  $t_F$  is 90% to 10% fall time;  $R_L$  is output load; and  $C_L$  is output capacitor.

#### **Output Discharge**

The device contains a  $R_{PD}$  = 65 $\Omega$  on-chip pull-down resistor for quick output discharge. The resistor is activated only during the switch reset time. In this way, the load  $I_Q$  can be tested easily, as showed in Figure 6.



# **SGM4073**

# **REVISION HISTORY**

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

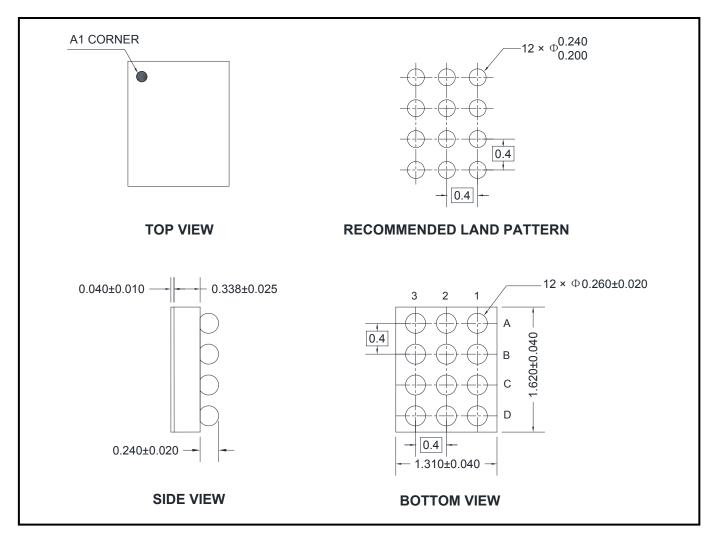
#### MAY 2017 - REV.A.2 to REV.A.3

Change the Tape and Reel, 5000 to 3000
DECEMBER 2016 – REV.A.1 to REV.A.2
Change the Maximum Continuous Current
OCTOBER 2016 – REV.A to REV.A.1

#### Changes from Original (MAY 2016) to REV.A



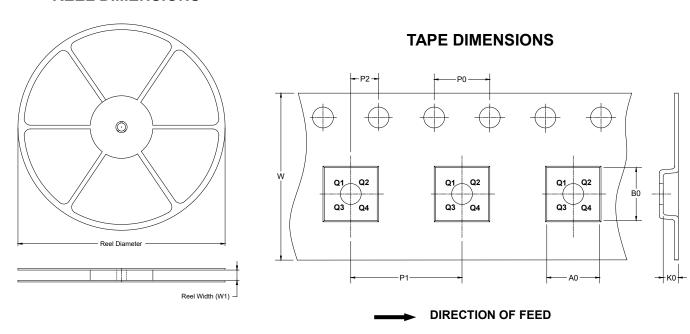
# PACKAGE OUTLINE DIMENSIONS WLCSP-1.31×1.62-12B



NOTE: All linear dimensions are in millimeters.

# TAPE AND REEL INFORMATION

#### **REEL DIMENSIONS**

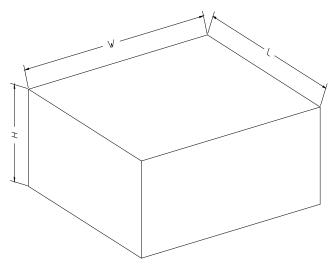


NOTE: The picture is only for reference. Please make the object as the standard.

#### **KEY PARAMETER LIST OF TAPE AND REEL**

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
WLCSP-1.31×1.62-12B	7"	9.2	1.42	1.75	0.71	4.0	4.0	2.0	8.0	Q1

#### **CARTON BOX DIMENSIONS**



NOTE: The picture is only for reference. Please make the object as the standard.

#### **KEY PARAMETER LIST OF CARTON BOX**

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
7" (Option)	368	227	224	8
7"	442	410	224	18